AMENDMENTS TO THE CLAIMS:

This listing of claims will replace all prior versions, and listings, of claims in the application:

1. (Currently Amended) A solar cell comprising an electrode coated with lead-free solder;

wherein said electrode is formed of fired metal paste; and
wherein said metal paste contains powdery silver, powdery glass, an organic
vehicle, an organic solvent, phosphorous oxide, and halide.

- 2. (Cancelled)
- 3. (Currently Amended) The solar cell of claim 1, wherein <u>one any technique</u> of metal vapor deposition, <u>sputteringspattering</u>, and plating is used to <u>coat provide</u> said electrode.
- 4. (Original) The solar cell of claim 1, wherein said lead-free solder is one of Sn-Bi-Ag-based solder and Sn-Ag-based solder.
 - 5. (Cancelled)
- 6. (Original) A solar cell comprising an electrode coated with lead-free solder after said electrode is cleaned with flux including resin, a solvent, and a stabilizer for resin;

wherein said electrode is formed of fired metal paste; and
wherein said metal paste contains powdery silver, powdery glass, an organic vehicle, an
organic solvent, phosphorous oxide, and halide.

7. (Original) An interconnector for solar cells, comprising a metal core coated with lead-free solder:

wherein said electrode is formed of fired metal paste; and
wherein said metal paste contains powdery silver, powdery glass, an organic vehicle, an
organic solvent, phosphorous oxide, and halide.

8. (Currently Amended) A solar cell string comprising solar cells including electrodes interconnected with interconnectors, wherein said electrodes each are each coated with lead-free solder and said interconnectors each also coated with lead-free solder;

wherein said electrode is formed of fired metal paste; and
wherein said metal paste contains powdery silver, powdery glass, an organic vehicle, an
organic solvent, phosphorous oxide, and halide.

- 9. (Original) The solar cell string of claim 8, wherein said lead-free solder used for said solar cell and said lead-free solder used for said interconector are identical in composition.
- 10. (Currently Amended) The string of claim 9, wherein Bi is contained in <u>both</u> at least one of said lead-free solder for said solar cell and said lead-free solder for said interconnector.
- 11. (Original) The solar cell of claim 4, wherein said lead-free solder contains 3 to 89 mass % Bi.

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- 12. (Original) The string of claim 10, wherein said lead-free solder contains 3 to 89 mass % Bi.
- 13. (Original) The string of claim 8, wherein Ag is contained in at least one of said lead-free solder for said solar cell and said lead-free solder for said interconnector.
- 14. (Original) The solar cell of claim 4, wherein said lead-free solder contains 3.5 to 4.5 mass % Ag.
- 15. (Original) The string of claim 13, wherein said lead-free solder contains 3.5 to 4.5 mass % Ag.
- 16. (New) A method of forming a solar cell having an electrode, comprising the steps of:

forming said electrode,

cleaning said electrode with flux including a resin, a solvent, and a stabilizer for said resin, and

coating said cleaned electrode with lead-free solder.